



In re the Application of: Akira MATSUDA et al.

Group Art Unit: 1775

Application Number: 10/719,020

Examiner: Michael E. Lavilla

Filed: November 24, 2003

Confirmation Number: 9168

For:

PLATING BATH FOR FORMING THIN RESISTANCE LAYER,

METHOD OF FORMATION OF RESISTANCE LAYER,

CONDUCTIVE BASE WITH RESISTANCE LAYER, AND CIRCUIT

**BOARD MATERIAL WITH RESISTANCE LAYER** 

Attorney Docket Number:

032130

Customer Number:

38834

## PETITION FOR EXTENSION OF TIME

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450 June 27, 2007

Sir:

Applicants petition the Commissioner for Patents to extend the time for response to the Office Action dated March 7, 2007 for one month from June 7, 2007 to July 7, 2007.

Attached please find a check in the amount of \$120.00 for the cost of the extension. If any additional fees are due in connection with this paper, please charge Deposit Account No. 50-2866.

Respectfully submitted,

WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP

Limited Recognition

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120.00 OP

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Attachment: Check of \$120.00